



# CERTIFICATE OF ACCREDITATION

## The ANSI National Accreditation Board

Hereby attests that

**Resion, LLC**

7060 Havertys Way  
Lakeland, FL 33805

Fulfills the requirements of

**ISO/IEC 17025:2017**

and the

**AS6171 Detection of Suspect/Counterfeit Parts Accreditation Program**

In the field of

**TESTING**

This certificate is valid only when accompanied by a current scope of accreditation document.  
The current scope of accreditation can be verified at [www.anab.org](http://www.anab.org).

Jason Stine, Vice President

Expiry Date: 20 December 2024

Certificate Number: AT-3160



This laboratory is accredited in accordance with the recognized International Standard ISO/IEC 17025:2017.  
This accreditation demonstrates technical competence for a defined scope and the operation of a laboratory  
quality management system (refer to joint ISO-ILAC-IAF Communiqué dated April 2017).

## SCOPE OF ACCREDITATION TO ISO/IEC 17025:2017

**Resion, LLC**  
7060 Havertys Way  
Lakeland, FL 33805  
Anne Poncheri [aponcheri@resion.com](mailto:aponcheri@resion.com)  
516 620 0135

### TESTING

Valid to: **December 20, 2024**

Certificate Number: **AT-3160**

In recognition of a successful assessment to ISO/IEC 17025:2017 General Requirements for the competence of Testing and Calibration Laboratories, AS6171 General Requirements, and the requirements of the ANAB SR 2429 – Labs Performing Detection of Suspect/Counterfeit Parts Under AS6171 program, accreditation is granted to **Resion, LLC** to perform the following AS6171 slash sheet tests:

#### Non-Destructive Testing

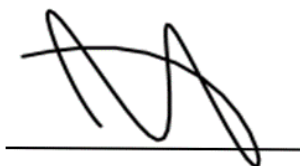
Specific Tests and/or Properties Measured	Specification, Standard, Method, or Test Technique	Items, Materials or Product Tested	Key Equipment or Technology
Radiographic Examination / Inspection	Internal Procedure: WI 60-06 IDEA-STD-1010B AS6081 AS6171/5	Electrical, Electronic and Electromechanical (EEE) Components	Glenbrook RTX-113
Visual Inspection	Internal Procedure: WI 60-04 IDEA-STD-1010B AS6081 AS6171/2 Method A, Method B, excluding weight	Electrical, Electronic and Electromechanical (EEE) Components	Keyence VHX-970F
Elemental Content by XRF	Internal Procedure: WI 60-08 IDEA-STD-1010B AS6081 AS6171/3	Electrical, Electronic and Electromechanical (EEE) Components	Fischer-XDAL 237 Benchtop XRF

## Mechanical

Specific Tests and/or Properties Measured	Specification, Standard, Method, or Test Technique	Items, Materials or Product Tested	Key Equipment or Technology
Decapsulation and Die Verification	Internal Procedure: WI 60-07 IDEA-STD-1010B AS6081 AS6171/4 Chemical Decapsulation Bake Method Mechanical Disassembly	Electrical, Electronic and Electromechanical (EEE) Components	Nisene Jet-Etch Decapulator, Oven, Meiji MC50T
Solderability	Internal Procedure: WI 60-14 J-STD-002	Electrical, Electronic and Electromechanical (EEE) Components	Solder Pot Thermocouple
Remarking/Resurfacing	Internal Procedure: WI 60-05 IDEA-STD-1010B AS6081 AS6171/2 Method C and D	Electrical, Electronic and Electromechanical (EEE) Components	Chemical Test
Dimensions	Internal Procedure: WI 60-04 MIL-STD-883 Method 2016 IDEA-STD-1010B AS6081, AS6171/2, Method E	Electrical, Electronic and Electromechanical (EEE) Components	Keyence VHX-970F Digital Calipers
Scrape Test	Internal Procedure: WI 60-05 IDEA-STD-1010B AS6171/2 Method D	Electrical, Electronic and Electromechanical (EEE) Components	Mechanical Removal of Surface

Note:

1. This scope is formatted as part of a single document including Certificate of Accreditation No. AT-3160.



Jason Stine, Vice President